Trends in
Opto-electro & Optical Communication

ISSN: 2231-0401 (Online)
ISSN: 2347-9957 (Print)
Volume 16, Issue 1, 2026
January–April
DOI (Journal): 10.37591/TOEOC

https://journals.stmjournals.com/toeoc

Review TOEOC

When Light Talks: The Realm of Optoelectronic Communication

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Abstract

The basic principles of optoelectronic systems are discussed. In these systems, electrical signals are converted into optical signals for high-speed, long-distance communication and then converted back into electrical signals at the receiver. This study highlights the essential components, including light sources, optical fibers, modulators, and photodetectors, that enable the efficient transmission of information with minimal loss and interference. The paper also discusses the advantages of optoelectronic communication over conventional electronic systems, including higher bandwidth, immunity to electromagnetic interference, and enhanced security. The study further explores emerging applications in telecommunications, Internet infrastructure, medical technology, and space communication, demonstrating the growing importance of this technology in modern society. To highlight ongoing technological advancements, recent developments in integrated photonics, silicon-based optical devices, and hybrid communication systems are examined. The crucial role of optoelectronics in global connectivity is demonstrated through its support for next-generation networks, including 5G and beyond. Finally, current challenges and prospects, including the integration of photonic circuits and the development of faster, more energy-efficient devices, are discussed to provide a comprehensive overview of this rapidly evolving field. The study concludes by identifying key research directions for achieving seamless integration between electrical and photonic systems to improve performance and scalability.

Keywords: Optoelectronic communication, fiber-optics, photodetector, modulation of light, transmission of signals, optical fiber

INTRODUCTION

Electrical signals dominated long-distance telecommunications until the mid-1970s, when limited transmission capacity became a significant constraint. The introduction of optical fiber transmission in the mid-1970s marked the beginning of the telecommunications revolution. Today, optical fiber forms the backbone of the information technology infrastructure and is used not only for traditional telephone services but also for high-speed Internet access and numerous other applications. Optical-fiber communication has become the standard for long-haul telecommunications, replacing conventional copper-based transmission systems.

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Received Date: April 29, 2026
Accepted Date: April 29, 2026
Published Date: April 30, 2026

Citation: Manjula Mallya M., V. Basil Hans. When Light Talks: The Realm of Optoelectronic Communication. Trends in Opto-electro & Optical Communication. 2026; 16(1): 1–14p.

Optoelectronic communication involves the transmission of information over optical links using devices such as light sources, photodetectors, and other optoelectronic components, with electrical signals at the input and/or output. It provides the highest bandwidth over the longest transmission distances at the lowest cost per unit of information carried among current communication technologies [1]. Historically and commercially, optoelectronic communication has played a vital role, with the optoelectronic interconnection research community developing systems capable of data rates of up to 500 Gbit/s over transmission distances exceeding

20 km. It is also a key component of the global optical network, enabling the connection of electrically processed and optically transmitted information across both access and transport networks [2].

Interest in optoelectronic communication has grown substantially because of rapid technological advances across multiple sectors. Strategic economic studies indicate that photonics-based transmission technologies can significantly reduce the cost per unit of throughput compared with current state-of-the-art systems. At the same time, optical transmission has become well established in the engineering community, and many high-capacity transmission requirements are now met by commercially available devices. Furthermore, the rapid expansion of the Internet and the continuously increasing demand for bandwidth across the telecommunications, enterprise, and data center sectors continue to drive the commercial adoption of optoelectronic communication technologies.

THE FOUNDATIONS OF OPTOELECTRONIC COMMUNICATION

Modern optoelectronic communication encompasses a broad range of technologies that use photons or optoelectronic signals to transmit information. The term optoelectronic communication generally refers to information transmitted as optical signals, although it typically encompasses an entire technology stack, including the transmission and reception of large-scale binary data over single-mode, multimode, and free-space optical channels. Information conveyed in the form of light is therefore referred to as optoelectronic communication, whereas the term optical communication is generally reserved for communication systems that do not involve the measurement, processing, detection, or storage of significant amounts of binary data.

To describe the transmission and reception of binary information within the framework of the physical laws governing communication systems and transmission channels, three fundamental concepts must first be defined. These include the nature of an optical signal, the mechanisms by which a physical system or device encodes information onto an optical signal, and the methods by which a receiver retrieves the transmitted information from that signal. First, the class of optical signals capable of propagating through a physical channel with minimal distortion is defined. Next, the more general concept of distributing information across multiple optical signals is introduced. Finally, the transmission of binary information over a single optical signal is described. A linear on–off keying communication system is then presented, together with the algebraic expressions required to characterize the signal for efficient information transmission.

Photonics Principles

Light is the most versatile medium for information transmission. Emerging photonic crystals, advanced semiconductors, and novel materials, such as graphene, have significantly improved modulation formats. Fibers with negative dispersion are crucial for space-division multiplexing (SDM) in long-haul optical networks. Other key enabling technologies include larger mode-field diameters, which reduce bending losses, and polymer cladding, which protects tapered fibers. In newly developed structures, the introduction of an additional longitudinal degree of freedom enables multi-excitation, whereas conventional structures permit the manipulation of only a single signal property. Significant energy savings in long-haul communication systems can be achieved through the use of on-chip optophotonic switching circuits. Mode locking, nonlinear polarization rotation, and filamentation are promising techniques for the development of tunable lasers. Pulse-shape characteristics often directly influence pulse distortion. Consequently, advances in photonic materials and submicron fabrication have enabled on-chip, dual-core, ring-resonator-based lasers to support dual-pitch modes. This architecture provides the foundation for future low-threshold, high-repetition-rate optical transmission systems.

Techniques of Optical Modulation

Optical modulation techniques remain fundamental to optical communication systems. The two most common approaches are direct modulation of the laser current and external modulation using optical devices. The most widely used external modulators are Mach–Zehnder interferometers and

ISSN: 2231-0401 (Online), ISSN: 2347-9957 (Print)

electroabsorption modulators. Optical communication systems operating at data rates of 40 Gb/s or higher generally require external modulators to achieve effective control of the output signal. Mach–Zehnder modulators rely on the electro-optic effect in materials such as lithium niobate or gallium arsenide. Variations in the applied electric field produce corresponding changes in the refractive index, resulting in the conversion of phase modulation into amplitude modulation [3]. Equally important, modulation formats are designed to maximize spectral efficiency while minimizing the effects of noise, dispersion, and nonlinearities. Signals may be modulated using either return-to-zero (RZ) or non-return-to-zero (NRZ) formats, with the latter sometimes requiring pulse-shaping devices, such as Mach–Zehnder modulators or electroabsorption modulators [4].

Free-Space and Fiber Optical Links

Optoelectronic communication systems employ two primary transmission media: optical fibers and free-space optical (FSO) links.

For permanent or frequently used point-to-point connections, such as those in telecommunications networks, optical fibers are the preferred transmission medium when system requirements can be met. Optical fibers may be either single-mode or multimode. Multimode fibers typically have a core diameter of 50–60 µm, allowing multiple propagation modes and, consequently, multiple optical paths. They also have a wider acceptance angle, which relaxes alignment and coupling tolerances. However, multimode fibers are susceptible to intersymbol interference (ISI) because optical pulses propagate through different modes with different transit times. In contrast, single-mode fibers have a core diameter of less than 10 µm, allowing only one propagation mode. This characteristic improves the bandwidth–distance product (BDP) and makes single-mode fibers the preferred choice for long-distance, high-bit-rate communication systems [5].

Attenuation is the reduction in signal power caused by absorption and scattering. Total signal loss consists of transmission losses and connection losses, both of which determine the optical input power required to exceed the receiver sensitivity threshold. These losses depend primarily on the transmission medium, including the material, geometry, and specific properties of the optical fiber. Calculating the total link loss budget enables the determination of the maximum transmission distance. In addition, misalignment between the fiber, connectors, and other optical components results in coupling losses. Proper alignment and active adjustment during connector termination help optimize optical coupling efficiency.

Atmospheric effects, including attenuation, turbulence, and pointing jitter, significantly influence the performance of FSO communication systems, particularly in ground-to-airborne and airborne-to-satellite links. FSO communication is a wireless, line-of-sight technology that transmits information through the atmosphere using optical carriers rather than optical fibers [6].

Active tracking systems are employed to correct pointing instability, minimize signal loss, and maintain acceptable pointing jitter. Dedicated tracking algorithms lock onto fixed positions or follow moving targets to ensure reliable communication. FSO technology has been successfully demonstrated in ground-to-airborne and airborne-to-satellite communication links.

Atmospheric conditions, including fog, rain, dust, and turbulence, can attenuate or distort the optical beam. At the transmitter, the beam must be properly collimated to minimize beam divergence, whereas the receiver generally requires a sufficiently large aperture to maximize signal collection. The overall system performance depends on the optical alignment and antenna configuration. Unlike optical fiber communication, in which light propagates through glass fibers with an outer diameter of approximately 125–200 µm, FSO communication transmits optical signals through free space, such as air or vacuum. Under favorable weather conditions, FSO provides high-bandwidth wireless communication without the need for physical transmission media [7].

Photodetection and Signal Processing

In optical communications, various modulation formats are used to encode information onto optical signals for transmission. At the receiver, photodetectors convert the received optical signals into electrical signals. The photodetection process involves the absorption of incident light by the detector material, generating a corresponding electrical response [8]. The key performance parameters of a photoreceiver include responsivity (R), quantum efficiency, signal-to-noise ratio (SNR), and linearity [9]. The efficient conversion of optical signals into electrical signals is essential for both amplitude-modulated and phase-modulated systems. Analog-to-digital converters (ADCs) are key components of modern communication systems because they digitize analog signals, enabling digital processing and subsequent transmission [10]. Data transmission rate and resolution are critical parameters that must be considered when designing a communication system.

ARCHITECTURES FOR COMMUNICATION SYSTEMS

Optical communication systems are broadly classified into point-to-point links and optical networks. A basic point-to-point optical link consists of a transmitter, a receiver, and an optical transmission medium that carries the signal between them. Communication systems connect information sources to their intended destinations. The two most widely used types of optical communication networks are local area networks (LANs) and metropolitan area networks (MANs). All-optical light paths and asynchronous transfer mode (ATM) switches have been developed to realize all-optical, wavelength-routed network architectures. These technologies can transmit a variety of payloads, including voice, video, multimedia data, and control signals, over a single optical wavelength channel. Embedded supervisory functions maintain payload transmission and support network management activities, such as performance monitoring and fault isolation. A hybrid optical–electronic and optical–wireless communication system has also been developed to connect two LANs through an optical-fiber link [11].

Optical communication systems are broadly classified into three groups based on the configuration of the transmitter and receiver: source–destination link, star architecture, and point-to-multipoint architecture. A source–destination link is a direct optical link in which a single source is connected to a single destination. In a star architecture, multiple sources are connected to multiple destinations through a single optical link or fiber. A point-to-multipoint architecture is a configuration in which multiple sources are connected to a single destination node through multiple optical links or fibers.

Optical Point-to-Point Links

The physical medium of a point-to-point link carries information between a transmitter and a receiver. In optical point-to-point systems, the transmitter generates a modulated optical signal that is coupled into an optical transmission channel. The transmission medium may be free space or an optical fiber. The optical signal propagates through the medium to the optical receiver, which converts it into an electrical signal for further processing [1].

A transceiver is a combination of a transmitter and a receiver, together with the associated control circuitry. In optical point-to-point systems, the transmitter typically consists of a light source, optical modulators, and a control circuit. The transmitter modulates the data signal onto the optical carrier generated by the light source [3]. In a direct-termination point-to-point optical link, a separate light source is used for each transmission direction. This architecture is relatively simple and can be implemented at low cost. The performance of direct-termination point-to-point optical communication systems is primarily limited by nonlinear impairments, receiver noise, and timing jitter.

Optical Network Topologies

The system architecture is closely coupled with the optical network topology, which is a fundamental concept in the efficient implementation of optical communication systems. The network topology defines how switching and routing nodes are interconnected, as well as the architecture of the transmitters and receivers used in the communication links. There are many possible optical network

ISSN: 2231-0401 (Online), ISSN: 2347-9957 (Print)

architectures, each with its own advantages and disadvantages with respect to the performance measures discussed in Section 4.

A point-to-point topology provides a dedicated link between two nodes. In contrast, a star topology enables a single transmitter to communicate with multiple destinations, although all information passes through an intermediate switch. Other flexible network topologies include a tree topology, in which information can be distributed to multiple destinations over a single connection, and a ring topology, in which nodes are connected in a closed loop. Although mesh networks are the most sophisticated topology, they are also widely used and can be implemented in various configurations. Their multiple alternative communication paths improve network survivability in the event of a component failure. Integrating both the control and data planes in all-optical networks remains an open research challenge [5].

Integrated Optoelectronic Circuits

Optical interconnects, which use optical signals to overcome the bandwidth limitations of electrical interconnects, are increasingly being integrated into semiconductor circuits. As on-chip and chip-to-chip communication continues to achieve higher data rates, the demand for lightwave interconnects with capacities of 20 Gb/s and above continues to grow. For high-speed optical transmitter circuits that drive multiple transmission channels in parallel, one of the key challenges in improving package design flexibility is reducing device size and power dissipation. The hybrid integration of advanced electronic circuits and optical devices on silicon substrates offers a promising solution to these challenges.

The development of integrated circuits incorporating optical devices, high-speed optical waveguides, and high-speed electronic circuits for optical communication applications is progressing rapidly. The ultimate objective is to monolithically integrate a complete high-speed optoelectronic circuit onto a single semiconductor substrate, thereby enabling on-chip optical links with high data rates through parallel transmission and wavelength-division multiplexing (WDM). The importance of optoelectronic integrated circuits has increased further because of growing interest in optical interconnects for high-bandwidth, energy-efficient data transmission within sub-1 cm^2 electronic circuits.

Optoelectronic integrated circuits have enabled efficient, high-speed optical transmission over multiple channels through integrated optical transceivers designed for bandwidth-intensive short-reach interconnects. To further advance this field, optical interconnect architectures and mixed-signal circuit designs have been investigated to improve energy efficiency and reduce design complexity. These technologies are also essential for optical interconnects in large-scale integrated circuits, which must satisfy increasing bandwidth and energy-efficiency requirements to achieve high-performance computing and communication systems [2].

PERFORMANCE CONSIDERATIONS AND MEASUREMENTS

To operate efficiently, optoelectronic communication systems must satisfy various performance requirements [12]. These requirements include bandwidth and capacity, signal integrity and noise performance, power efficiency, and thermal management. Considerable research has been conducted to ensure that these requirements are met. This section examines the principal performance characteristics that determine the efficiency of modern optoelectronic communication systems.

Bandwidth and Capacity

Multiplexing enables several independent signals to be transmitted simultaneously over a single physical medium, thereby increasing transmission capacity. Optical signals can be multiplexed in the time, wavelength, space, or polarization domains, resulting in time-division multiplexing (TDM), WDM, SDM, and polarization-division multiplexing (PDM) [1].

One of the greatest achievements in information theory is Shannon's information theory, which establishes that, for a given channel bandwidth, there is a maximum channel capacity representing the highest achievable bit rate that can be transmitted with a negligible probability of error. State-of-the-art coherent WDM systems for optical communications have demonstrated capacities exceeding 100 Tb/s, more than 10 times the capacity of many currently deployed optical systems. These high Shannon limits are attributable to the large optical bandwidth and the inherently high data rates supported by such systems. Indeed, a record transmission capacity of nearly 4 Pb/s has been demonstrated over a distance of 121 km, with a considerable fraction of the transmitted data occupying frequencies below 1.40 THz. In practice, however, channel impairments, network congestion, capacity bottlenecks, and implementation constraints can substantially reduce the maximum achievable bit rate [13].

Signal Integrity and Noise

The geometric and material dissipation challenges at the microjunction scale present significant obstacles to emerging optical communication systems. The evolution of two-dimensional (2D) photonic and optoelectronic circuitry helps mitigate excess heat generation and limits hot-spot formation within the phosphor layer surrounding commercial laser diodes. The primary goal is to achieve transparent networks with an energy-per-bit of less than 1 eV at the circuit output. The limited photonic energy budget available within the multi-bit batch-plus-one method demonstrates energy conservation along the line-card path of an optoelectronic circuit operating at an intrachip data rate approaching 300 Gb/s. Performance degradation occurs at very high data-rate cascades, where Z-sensitivity, together with the balance between residual and differential signals, influences gearbox performance at high line-carrier speeds [12].

Power Efficiency and Thermal Management

Power efficiency and thermal management are important challenges in modern optoelectronic systems [6]. Power budgeting is now commonly expressed in terms of energy per bit rather than total power consumption, introducing the additional requirement of managing power dissipated outside the photonic domain [14]. These calculations incorporate both photonic and electronic power budgets, particularly in integrated systems. Thermal management involves techniques for controlling activity factors at the signal and clock levels, enabling effective static and dynamic voltage scaling while maintaining performance requirements. Heat is dissipated through conduction from the active components to the substrate, conduction within the substrate, and convection to the surrounding air. Thermal effects, as well as offset, dispersion, and shot noise, continue to present significant challenges.

The principal challenge for current and future systems is maintaining signal integrity, particularly at high data rates and with large numbers of components, as reflected in the energy-delay product. One approach to mitigating this issue is optical-in/optical-out (O^3) demultiplexing, although it introduces additional design challenges.

DRIVING TECHNOLOGIES

The advent of WDM has greatly increased the capacity of optical communication systems and accelerated the adoption of optical technologies. It is a key enabler for long-haul, metropolitan, and short-reach optical links. Current research and technological developments are focused on extending the WDM paradigm to further increase multiplexing capacity. WDM operates by dividing the optical carrier spectrum into multiple wavelength channels, analogous to the frequency-division multiplexing used in traditional radio broadcasting. Coarse WDM (CWDM) provides up to 18 channels spanning 1270 to 1610 nm with 20 nm channel spacing. Dense WDM (DWDM) commonly uses 50 GHz channel spacing and operates primarily in the C- and L-bands (approximately 1525–1610 nm). Emerging approaches based on macro- and microring resonators that implement frequency-conversion techniques offer promising future multiplexing solutions. These techniques increase channel capacity without significantly encroaching on the transmission band of the optical carrier [1].

Optical amplification increases the power of modulated optical signals in both the linear and nonlinear operating regimes. Amplification occurs within the same spectral region as signal transmission (in-line amplification); therefore, the amplifier bandwidth should cover a sufficiently wide wavelength range. High amplifier gain enables greater flexibility in channel spacing, multiplexing format, and wavelength allocation. Various optical amplifiers, including erbium-doped fiber amplifiers (EDFAs), Raman optical power amplifiers (ROPAs), and semiconductor optical amplifiers (SOAs), together with related laser architectures, are used in both research and commercial systems to satisfy the requirements of different transmission distances and channel densities. Key performance parameters, including gain, noise figure, saturation power, and reliability, are used to evaluate these optical amplifiers.

Photonic integrated circuits (PICs) integrate multiple photonic components and functions onto a single platform to improve system performance. Integration enhances size, weight, power consumption, cost, and manufacturing yield. However, the benefits of photonic integration have yet to be fully realized in practical systems, where hybrid integration across diverse wavelength bands is often required. Several fabrication platforms are commercially available or remain under active investigation, including indium phosphide (InP), silicon-on-insulator (SOI), silicon nitride (Si_3N_4), and polymer-based platforms. Challenges remain, including the limited availability of reliable components for emerging material systems and the complexity of optoelectronic integration. Continued advancement of PIC technology requires novel research, innovative device designs, and the re-evaluation of existing fabrication platforms.

Emerging FSO communication systems, characterized by low-cost transceivers, wide bandwidth, and eye-safe, invisible laser transmission, have strong potential for applications ranging from wireless backhaul to data-center interconnects. FSO links may be established between laser transmitters and receivers, including photodetectors and phototransistors. Pointing, acquisition, and tracking (PAT) is a fundamental technique for establishing reliable FSO links. In addition, both direct and indirect (externally modulated) visible-light communication (VLC) systems have been developed. Visible-light communication is gaining increasing attention because of its unique wavelength range, large available bandwidth, low electromagnetic interference, and compatibility with highly efficient solid-state lighting technologies.

Wavelength Division Multiplexing and More

WDM may be classified as either CWDM or DWDM, depending on the channel spacing within the amplification bandwidth of EDFAs. CWDM can support up to 18 channels in the 1550 nm transmission window, with channel spacing ranging from 20 to 240 nm, whereas DWDM provides channel spacing ranging from 0.4 to 1.6 nm. DWDM has attracted considerable attention because of its higher multiplexing capacity and greater flexibility in channel allocation. Consequently, chromatic dispersion must be carefully controlled. Simple channelization strategies, such as bandwidth slicing and fixed-wavelength routing, have been widely adopted in tightly channelized systems. Emerging technologies, including ultra-dense WDM, TDM, and PDM, promise substantial improvements in spectral efficiency for optical networking. However, nonlinear pulse-induced crosstalk remains one of the fundamental limitations of optical amplifiers [15].

Lasers and Optical Amplification

Optical amplifiers are general-purpose amplifiers that increase the power of optical signals. They are widely used in optical communication systems based on optical fibers, free-space links, and integrated photonics. Optical amplifiers do not require optoelectronic conversion; instead, signal processing is performed entirely in the optical domain [12]. Their basic characteristics, such as gain, noise figure, and saturation power, vary considerably depending on the operating principle and the gain medium employed. The four most commonly used types of optical amplifiers in communication systems are EDFAs, SOAs, ROPAs, and laser amplifiers. These amplifiers operate over the principal optical communication windows centered at approximately 1310, 1550, and 1650 nm.

The EDFA is the most widely used optical amplifier for long-haul communication at the 1550 nm wavelength. Because silica glass, the standard material used in optical fibers, is fully compatible with erbium-doped fiber technology, the EDFA remains the preferred choice even in emerging optical communication systems [16].

The SOA is used in applications ranging from directly modulated laser diodes to distributed feedback (DFB) laser systems and supports communication over both long-haul and access networks. 1310 nm and 1550 nm laser diodes are commonly integrated with coaxial connectors or fiber pigtails. In addition, 1490 nm SOAs for broadband community antenna television (CATV) applications have been developed using InGaP-based material systems [1]. Numerous approaches have been investigated for the monolithic or hybrid integration of optical and electronic components to facilitate widely used coaxial-to-fiber converters and radio frequency (RF)-over-fiber transceivers for upstream bidirectional data transmission.

The ROPA is the only optical amplifier designed specifically for radio-over-fiber (RoF) systems. A ROPA employs a unique architecture in which a low-frequency signal (typically a few hundred megahertz) is applied directly to the optoelectronic transmitter without requiring separate RF modulators. The 1310 nm laser used in these systems is not intended for WDM transmission over long distances. Compared with other optical amplifiers, ROPAs are generally less constrained by wavelength allocation than many WDM-based devices [17].

Lasers are widely used in optical communication systems as transmitters and, in some applications, as optical amplifiers, complementing EDFAs, SOAs, and ROPAs. Different laser architectures are designed for specific communication applications. Lasers are commonly employed to extend the transmission distance of optical fiber communication systems. Furthermore, the combination of broad wavelength coverage and WDM using multiwavelength laser arrays further increases communication capacity and transmission distance.

Integrated Photonic Circuits

Photonic integration is a key driver in the advancement of optical communication systems and continues to gain momentum. The development of PICs has progressed from research demonstrations to commercial deployment in high-speed optical communication systems. Existing PIC platforms are based on various combinations of silicon dioxide, silicon nitride, polymers, InP, gallium arsenide, and lithium niobate. This technology has attracted considerable interest because it offers photonic solutions for next-generation broadband optical communication systems, including optical data networks, in-home communication, data-center applications, and optical packet switching [11]. In integrated optical networks, the integration density of optical circuits is increased, multifunctional devices can be fabricated on a single chip, and packaging costs are reduced. The transition to all-optical systems is attractive because optical signals are less susceptible to electromagnetic interference than electrical signals. Although circuit design remains challenging, many integrated optical circuit modules are now commercially available.

One of the principal advantages of optical circuits is the elimination of electrical conversion stages, which (1) increases the number of interconnected devices without degrading performance and (2) enables the development of heterogeneous, low-cost, and scalable building blocks beyond the radio-frequency domain. Optical circuits have emerged as a viable solution for interchip and intrachip communication because of their high speed, large bandwidth, and immunity to electromagnetic interference compared with conventional electrical interconnects. The expansion of external optical links also increases the potential for signal degradation caused by complex packaging, harsh operating environments, and electromagnetic interference, thereby encouraging the adoption of optical interconnect technologies [18].

Free Space and Visible Light Communication

Light propagation through the atmosphere is an important aspect of FSO communication. The principal advantage of an atmospheric channel is that it eliminates the need for physical transmission media, thereby enabling communication without extensive infrastructure. However, alignment remains a significant challenge because maintaining pointing accuracy under adverse environmental conditions is more difficult than in fiber-based systems. Optical power transmission over an atmospheric link is governed primarily by atmospheric absorption and scattering caused by atmospheric constituents (e.g., gases, water droplets, and particulate matter), as well as by other free-space propagation effects, such as atmospheric turbulence. Various attenuation models and transmission characteristics under different atmospheric conditions (e.g., clear skies, aerosol-laden atmospheres, and misty or rainy conditions) enable the estimation of the maximum practical transmission distance for FSO communication systems in different applications.

Once an FSO link has been established, the simplest and often the most cost-effective approach is intensity modulation with direct detection (IM/DD). For indoor FSO systems, common modulation schemes include on–off keying (OOK), pulse-position modulation (PPM), and pulse-width modulation (PWM). Numerous studies have shown that OOK is well suited for short-range free-space communication, PPM for long-distance communication, and PWM for short-distance transmission. However, increasing demand for optical–wireless communication presents significant challenges as the available transmission bandwidth becomes increasingly congested. Consequently, advanced modulation and multiplexing techniques are expected to play a critical role in the next generation of FSO communication systems [19, 20].

APPLICATIONS AND USE CASES

Core and transport networks are typically organized into a three-tier architecture comprising the backbone, metro, and access networks. Backbone networks support the highest volumes of telecommunication traffic and provide primary and backup data links between telecommunication operators and Internet service providers (ISPs). Metro networks deliver high-capacity broadband services to businesses and end users in large metropolitan areas. Access networks connect end users to the nearest metropolitan switching facilities. The evolution of optical networking has been driven by the increasing bandwidth demands of backbone and metro fiber-optic networks. Greater optical bandwidth is required to further expand the capacity of these networks. At the same time, the telecommunications industry is evolving toward cloud computing and software-defined networking, making latency requirements increasingly stringent. Moreover, reliability remains a fundamental challenge in telecommunications networks. Optical networks are designed to add, drop, bypass, or switch optical signals across interconnected optical networks, thereby improving network robustness and minimizing service disruptions [1].

Telecommunications Infrastructure

Fiber-optic connections form the foundation of modern telecommunications infrastructure and data transmission. The global demand for bandwidth and the volume of data to be transmitted continue to increase rapidly each year. Internet bandwidth demand is growing by approximately 38% per year, although the growth rate is projected to slow to 34% because of changes in traffic patterns [1]. Location-based services, social media, video streaming, and Voice over Internet Protocol (VoIP) services continue to drive this increasing demand. For present and near-future telecommunication systems, three key characteristics must be considered: data-carrying capacity, end-to-end latency, and reliability. Data-carrying capacity refers to the amount of data that can be transmitted over a given period. Demand is driven by the wide range of applications that require dramatically different transmission capacities. Projected network capacities are 10 Tb/s by 2020 and 100 Tb/s by 2030 [13]. The rapid evolution of bandwidth-intensive applications continues to drive the need for higher network bandwidth.

Interconnects for Data Centers

Data centers rely on fiber-optic connectivity to enable high-speed, long-distance communication between servers, thereby supporting scalable storage and computational capacity. As the demand on electrical interconnects increases because of growing service requirements, the cost of sustaining high data throughput becomes prohibitive, prompting a transition to optical interconnects. Such transitions often represent the first large-scale deployment of optical communication equipment within data centers. As traffic volumes continue to grow, the deployment of optical switches also becomes necessary to enable fully optical switching [17]. Accordingly, optical links can be classified as intra-data-center and inter-data-center links, with the former currently accounting for the majority of deployments. Private optical networks for intra-data-center communication are primarily based on short-reach links directly coupled to vertical-cavity surface-emitting lasers (VCSELs). These networks typically employ simple modulation formats, such as NRZ or pulse-amplitude modulation (PAM), operating at data rates of 25, 50, or 100 Gbit/s, or over four channels operating at 25 Gbit/s each. Power consumption in these links must also be carefully controlled, and recent implementations have achieved 20 dB of signal attenuation while maintaining a total power consumption of approximately 280 mW.

Sensing, Measurement and Health Monitoring

Optical sensors have gained considerable interest in medical diagnostics and healthcare. Unlike conventional sensors based on microelectromechanical systems (MEMS) or semiconductor technology, optical sensors offer several advantages, including small size, multiplexing capability, chemical inertness, and immunity to electromagnetic interference. They provide rapid, highly sensitive responses that are well suited for real-time monitoring, making them ideal for biomedical, structural health, and industrial applications. Optical-fiber-based approaches are especially attractive for healthcare applications because they enable continuous, noninvasive, and highly accurate monitoring of heart rate and body temperature. Optical fiber sensors may be extrinsic, in which light is transmitted to and from a separate sensing device, or intrinsic, in which the fiber itself serves as the sensing element [21].

Real-time health-monitoring technologies are still under active development. Because of their significant potential, wearable electronic devices have been the focus of extensive research and development. Compared with conventional biomedical monitoring systems, these devices are small, inexpensive, noninvasive, and convenient. They have the potential to transform healthcare by continuously monitoring vital signs and providing timely notification of physiological changes. Optical sensors, such as photoplethysmography (PPG) sensors and fiber Bragg gratings (FBGs), have been widely studied and implemented in wearable devices. These sensors can continuously and sensitively monitor numerous physiological parameters using optical sensing principles. Consequently, optical sensing devices based on fundamental optical technologies have been extensively explored and applied in medical diagnosis and health assessment [22].

New Beyond-20 Applications

Emerging applications operating at data rates above 20 Gb/s are expected to influence a wide range of fields, including real-time video, medical diagnostics, intelligent transportation systems, and the Internet of Things (IoT), all of which have stringent requirements for capacity, reliability, bandwidth, and energy efficiency [1]. These applications will rely heavily on high-performance optical communication systems, beginning with the underlying transport infrastructure. Two promising research directions are optical–wireless communication and millimeter-wave transmission, both of which benefit from the rapid advances in optical components and have the potential to support long-range access networks. Wireless systems are particularly well suited for applications that require rapid deployment or high installation flexibility [23].

CHALLENGES AND FUTURE PERSPECTIVES

Optical communication is the backbone of the information age, offering enormous bandwidth through optical fibers to meet society's growing data transmission needs. Its applications include global high-capacity networks that form the backbone of the Internet, as well as data-center interconnects. The field is broad and evolving rapidly, with researchers and industry professionals working to meet the increasing demand for higher capacity, lower cost, and improved energy efficiency while adapting to emerging services and technologies [1].

Optical technologies will play a critical role in the future of global connectivity. Worldwide bandwidth demand continues to double every two to three years, creating an urgent need for technologies that enable cost-effective scaling of network capacity and density. Advances in individually addressable modulation formats and higher data rates will help meet evolving connectivity requirements. There is considerable interest in experimental technologies capable of extending transmission capacities beyond 20 Tb/s to support future ubiquitous global connectivity. Emerging applications across numerous sectors have created a wide range of new services and revenue opportunities.

This broad range of opportunities presents several important challenges. Advances in materials, fabrication, interfaces, packaging, assembly, integration, and manufacturing are required to enable wider adoption and investment. Greater efforts are also needed to establish standardized protocols and interfaces that support interoperable interconnect solutions in multi-platform, multi-vendor environments, where cross-domain communication remains essential. Another common objective is seamless compatibility across diverse platforms with minimal intermediaries that affect performance, thereby preserving the desired level of interoperability. In addition, the environmental sustainability of deployed solutions—including material selection, the use of scarce resources, pollution, and end-of-life recyclability—will continue to shape design strategies and technological development, even for highly innovative or long-term solutions.

Technological and Production Challenges

PIC technology, driven by advances in materials and fabrication processes for low-cost, high-performance optical components, has made significant progress. However, considerable technical and manufacturing challenges remain before the full potential of low-cost integrated optical transceivers for parallel optical interconnects and system-on-chip applications can be realized [1].

Several high-performance optical materials, including high-index silicon nitride, soft glass, and low-index polymers, remain under development or have limited commercial availability. In addition, long qualification cycles are required to fully characterize these materials and assess their compatibility with established foundry fabrication and packaging processes. Further work is needed to optimize optical mode matching at the interfaces between active and passive materials with different refractive indices to achieve sufficient optical power for reliable externally modulated distributed feedback (DFB) lasers. Advances are also required in photonic–electronic coupling designs to enable thinner active layers and lower drive voltages.

The limited availability of reliable commercial sources for several key active materials required for the on-chip generation of wavelength-tunable and regenerative optical pulses constrains the development of PICs based on advanced platforms. Further research is needed to develop polymer waveguides and associated grating structures that enable reliable coupling between advanced silicon photonic platforms and conventional telecommunications and very-large-scale integration (VLSI) electronic technologies. Additional improvements in polymer-based coupling technologies are also needed to facilitate large-scale, multi-node integration of advanced photonic devices and signal-processing systems.

Standardization and Interoperability

In optoelectronic communication, standard interfaces, protocols, and system compatibility are required to facilitate system configuration, control, and automation among products from different vendors and across multiple platforms. The standardization of optical communications began in the 1980s and has continued to expand at an accelerated pace, encompassing areas such as optical interfaces, transceiver characteristics, modulation formats, network management, and digital control. As optical communication technology evolves toward systems in which the internal components of transceivers (e.g., photodiodes, light sources, and equalizers) can be independently selected, the overall performance of an optical link is no longer easily determined from individual parameters such as bit rate or optical SNR. Consequently, establishing common methods to measure, describe, and specify performance has become increasingly important [1].

Sustainability and Environmental Issues

The environmental impact can be assessed at several life-cycle stages, from fabrication to deployment, and mitigated through green photonics measures as follows:

- *Reduced material usage:* Silicon, polymers, glass, and thin-film technologies can be used to conserve resources.
- *Reuse of materials:* Dielectric materials for green photonics should utilize relatively nonhazardous materials. Hybrid machining technologies can reduce chemical consumption and enable zero-liquid-waste production.
- *Rapid prototyping and research applications:* Photonic chips are often used as rapid prototypes and can support research and development (R&D) activities. Numerous start-up companies are actively involved in multi-project wafer (MPW) services.
- *Reduction of chemical waste:* Certain solvents can be eliminated or contained. The use of nontoxic photopolymers and polymer laser discs can reduce chemical waste. Durable materials for polymer electrolyte resins (PERs), dielectrics, and polymers contribute to sustainable photonic technologies.
- *Power efficiency:* Pre-biasing correction, electromagnetic interference prevention, and improved energy-management strategies enhance system efficiency.
- *Renewable energy integration:* Modulated sunlight can serve as an alternative energy source to promote green technologies.
- *Optical data storage and photonic technologies:* Holography enables optical data storage, while green laser technologies and advanced photonic workstations support sustainable applications.
- *System multifunctionality and regulatory design:* Adaptive management approaches enable system multifunctionality, service multiplexing, and regulatory design optimization. Surface roughness control, multi-interface and multilevel three-dimensional (3D) structures, and nontransitive gas regulation techniques enhance device performance.
- *Advanced photonic manufacturing:* Device smoothing techniques, clean-space photonic fabrication, addressable video data recording discs, 3D photonic structures, and solid-state focusing technologies contribute to the development of sustainable photonic systems.
- *Waste management of nonbiodegradable materials:* Sustainable alternatives, such as silicon-based stretchable and elastic polymers, are being developed to reduce the environmental impact of nonbiodegradable materials. Shape-shifting polymers based on shrinkage principles can undergo actuation through differential contraction and geometric deformation. These materials can exhibit quadrilateral cross-sections and programmable shape changes through controlled actuation mechanisms.
- *Smart polymer materials:* Such polymers possess shape-memory and self-relaxation capabilities, enabling transitions between deformed and recovered states. The absence of defects and the ability to restore the original shape are important characteristics of these materials. Structural designs, including triangular lattice beams, straight diagonal configurations, and parallel arrangements, contribute to their mechanical performance.
- *Conductive and insulating properties:* Conductive cable liners and polymer-based structures provide controlled electrical pathways while maintaining insulation from conventional electrodes, resulting in improved structural stability and preservation of material properties.
- *Advanced fabrication and photonic applications:* Although lithographic processes may degrade certain materials, advances in fabrication techniques have improved the availability and processing of functional polymers. Three-photon interactions, photofluorinated/acidic materials, and polymer-based systems enable diffraction-based structures and multifunctional control.
- *Multifunctional polymer technologies:* Polymers provide simultaneous control over multiple parameters and demonstrate reversible behavior under extreme conditions. Advanced laser-

writing techniques enable the fabrication of small-scale structures and stencil-based patterns for high-volume manufacturing.

CONCLUSION

Lightwave communications are essential to the present information era because they enable the transmission of large quantities of data through optical fibers and meet the demand for long-distance, high-capacity transport. Optical links form the backbone of worldwide high-capacity networks that support the Internet and enable intra-data-center interconnects. As shown in Figure 1, these systems vary significantly, ranging from long-distance links between continents to short interconnects between electronic components on a single board. If clock recovery is particularly imprecise, the performance of free-space communication can be poor, even over short distances. Such large bandwidths are suitable for transferring extensive data collections, especially datasets larger than hundreds of gigabytes. These datasets frequently include high-resolution video content. Therefore, optically modulated signals operating within these ranges exhibit large temporal bandwidths, representing multi-gigabit-per-channel formats.

Termination can take various forms, commonly involving a receiver comprising an electro-optic or optoelectronic device that converts variations in light intensity, phase, or frequency into corresponding electrical voltage or current signals. The input signals in the electrical domain serve as the basis for further data processing; routing, switching, and signal regeneration are typically performed electronically. Consequently, coupling an input continuous lightwave or modulated signal through an optoelectronic transducer and returning it to the optical domain as a regenerated signal remains a common practice. The worst-case scenario is generally associated with signal degradation, in which the signal progressively deviates from its expected waveform after each transmission cycle. In device-performance evaluation, a drum signal isolated from the active signal through an auxiliary coupler and directed to a photodetector represents a commonly used output format.

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